



DMP1070U

P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(on)} Max	I _D T _A = +25°C
-12V	$31m\Omega$ @ $V_{GS} = -4.5V$	-5.4A
-120	45mΩ @ V _{GS} =-2.5V	-4.5A

Description

This new generation MOSFET is designed to minimize the on-state resistance (R_{DS(on)}) while maintaining superior switching performance, which makes the device ideal for high-efficiency power-management applications.

Applications

- DC-DC Converters
- **Power Management Functions**
- Analog Switch

Features and Benefits

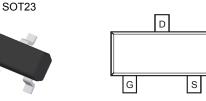
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- **ESD Protected**
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen- and Antimony-Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

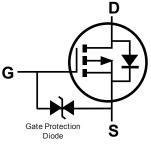
Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish—Matte Tin Annealed Over Copper Lead-Frame. Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.009 grams (Approximate)









Top View

Pin Configuration

Internal Schematic

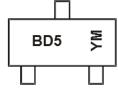
Ordering Information (Note 4)

Part Number	Case	Packaging
DMP1070U-7	SOT23	3,000/Tape & Reel
DMP1070U-13	SOT23	10,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3).compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, see https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



BD5 = Marking Code YM = Date Code Marking \overline{Y} = Year (ex: I = 2021) M = Month (ex: 9 = September)

Date Code Key

Year	2021	2022	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code		J	K	L	М	N	0	Р	R	S	T	U
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec



Maximum Ratings (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V_{DSS}	-12	V		
Gate-Source Voltage			V_{GSS}	±8	V
Continuous Drain Current (Note 6) V _{GS} = -4.5V	Steady State	T _A = +25°C T _A = +70°C	I _D	-5.4 -4.3	А
Maximum Continuous Body Diode Forward Curren	Is	-1.8	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 19	%)		I _{DM}	-33	Α

Thermal Characteristics (@ T_A = +25°C, unless otherwise specified.)

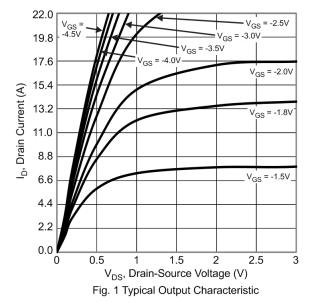
Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	P _D	0.89	W
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	140	°C/W
Total Power Dissipation (Note 6)	P _D	1.4	W
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	89	°C/W
Thermal Resistance, Junction to Case (Note 6)	Rejc	17	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@ T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)				I.	I.	-
Drain-Source Breakdown Voltage	BV _{DSS}	-12	_	_	V	V _{GS} = 0V, I _D = -250μA
Zero Gate Voltage Drain Current (T _J = +25°C)	I _{DSS}	_	_	-1.0	μA	V _{DS} = -12V, V _{GS} = 0V
Gate-Source Leakage	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 8V$, $V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	-0.3	_	-1.0	V	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$
			23	31		$V_{GS} = -4.5V$, $I_D = -4.0A$
Static Drain-Source On-Resistance	R _{DS(on)}	_	33	45	mΩ	$V_{GS} = -2.5V, I_D = -3.5A$
			46	75		$V_{GS} = -1.8V$, $I_D = -2.7A$
Diode Forward Voltage	V _{SD}	_	-0.6	-1.0	V	V _{GS} = 0V, I _S = -1A
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	C _{iss}	_	143	_	pF	
Output Capacitance	Coss	_	123	_	pF	$V_{DS} = -10V, V_{GS} = 0V$ f = 1.0MHz
Reverse Transfer Capacitance	C _{rss}	_	16	_	pF	1 - 1.00012
Gate Resistance	R _G	_	401	_	Ω	V _{DS} = 0V, V _{GS} = 0V, f = 1.0MHz
Total Gate Charge	Q _G	_	11.5	_	nC	
Gate-Source Charge	Qgs	_	1.4	_	nC	$V_{GS} = -4.5V$, $V_{DS} = -10V$, $I_{D} = -4A$
Gate-Drain Charge	Q _{gd}	_	2.9	_	nC	
Turn-On Delay Time	t _{D(on)}	_	125	_	ns	
Turn-On Rise Time	t _R	_	192	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time	t _{D(off)}	_	685	_	ns	$R_L = 2.5\Omega$, $R_G = 3.0\Omega$
Turn-Off Fall Time	t _F	_	950	_	ns	

 Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate..
Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing. Notes:





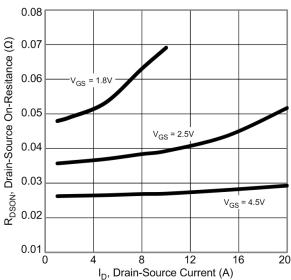


Fig. 3 Typical On-Resistance vs Drain Current and Gate Voltage

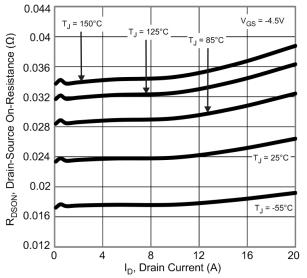


Fig. 5 Typical On-Resistance vs Drain Current and Junction Temperature

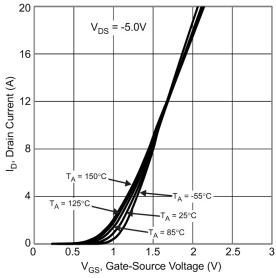


Fig. 2 Typical Transfer Characteristic

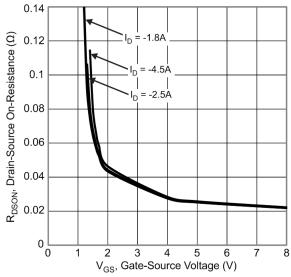


Fig. 4 Typical Transfer Characteristic

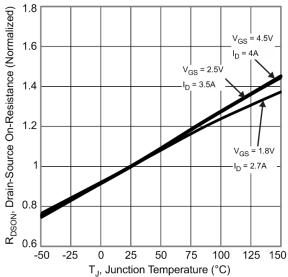


Fig. 6 On-Resistance Variation with Junction Temperature



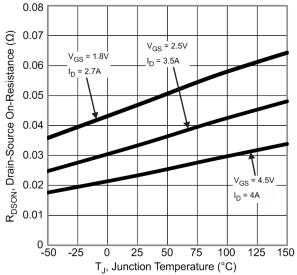


Fig. 7 On-Resistance Variation with Junction Temperature

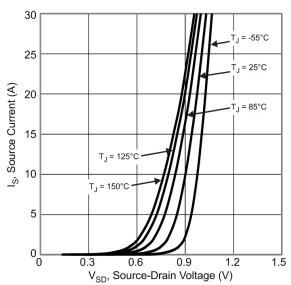
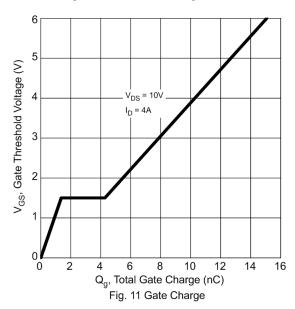


Fig. 9 Diode Forward Voltage vs Current



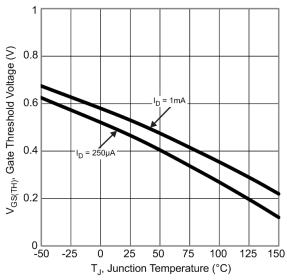


Fig. 8 Gate Threshold Variation vs Junction Temperature

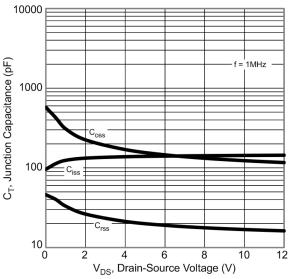
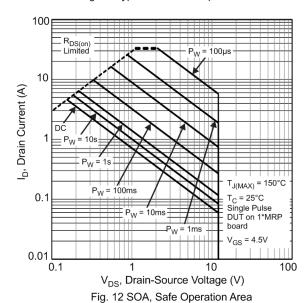


Fig. 10 Typical Junction Capacitance





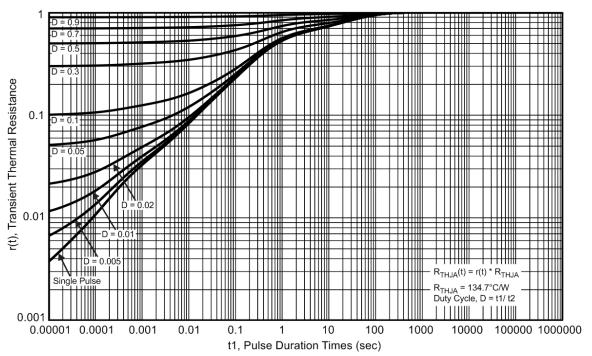


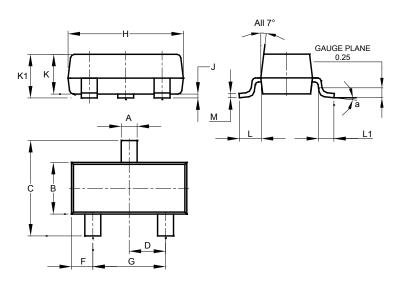
Fig. 13 Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23

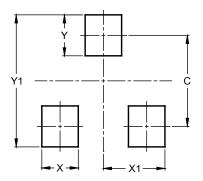


SOT23						
Dim	Min	Max	Тур			
Α	0.37	0.51	0.40			
В	1.20	1.40	1.30			
С	2.30	2.50	2.40			
D	0.89	1.03	0.915			
F	0.45	0.60	0.535			
G	1.78	2.05	1.83			
Н	2.80	3.00	2.90			
J	0.013	0.10	0.05			
K	0.890	1.00	0.975			
K1	0.903	1.10	1.025			
L	0.45	0.61	0.55			
L1	0.25	0.55	0.40			
М	0.085	0.150	0.110			
а	0°	8°				
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)
С	2.0
Х	0.8
X1	1.35
Υ	0.9
Y1	2.9



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